

TA1268N

I²C BUS CONTROL NTSC 1CHIP COLOR TV IC

TA1268N provides PIF, SIF, Video, Chroma and Deflection circuit for NTSC Color TV. TA1268N also provides Audio-Video Switch and Text interface. TA1268N combine these functions in a 56pin dual-in-line shrink-type plastic package.

TA1268N realizes rationalization of various alignments and controls by bus control system.

FEATURES

PIF Circuit

- PLL Type IF Demodulation (Bus alignment)
- Adjustment Free AFT without Tank Coil
- RF AGC Output (Delay point : Bus alignment)
- Dual Time Constant Fast AGC

Video Circuit

- Black Stretcher
- DC Restoration Circuit
- D.L. Aperture Compensate Circuit (Bus Control)
- Internal Filter Auto-adjust Circuit (Fsc link type)
- Uni-color Circuit (Bus control)
- 3.58MHz Trap Filter Circuit (Bus on / off)
- Y Delay Line Circuit

Chroma Circuit

- Color Control Circuit (Bus control)
- Tint Control Circuit (Bus control)
- B.P.F. / T.O.F. Circuit (Bus select)
- Included ACC / Killer Filter

SIF Circuit

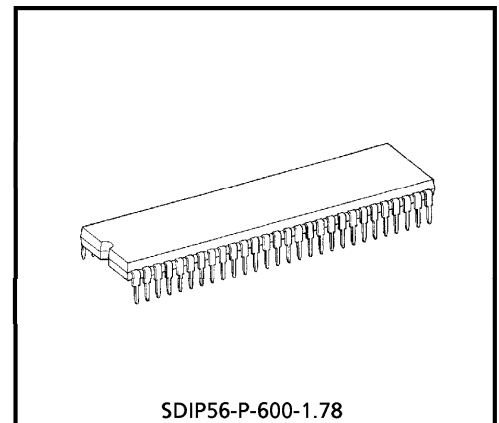
- Inter Carrier SIF System
- External Sound Select Switch (Bus select)
- Attenuator Circuit (Bus control)

TEXT Circuit

- Linear RGB Input
- Cut Off / Drive Adjustment (Bus adjustment)
- RGB Primary Color Output

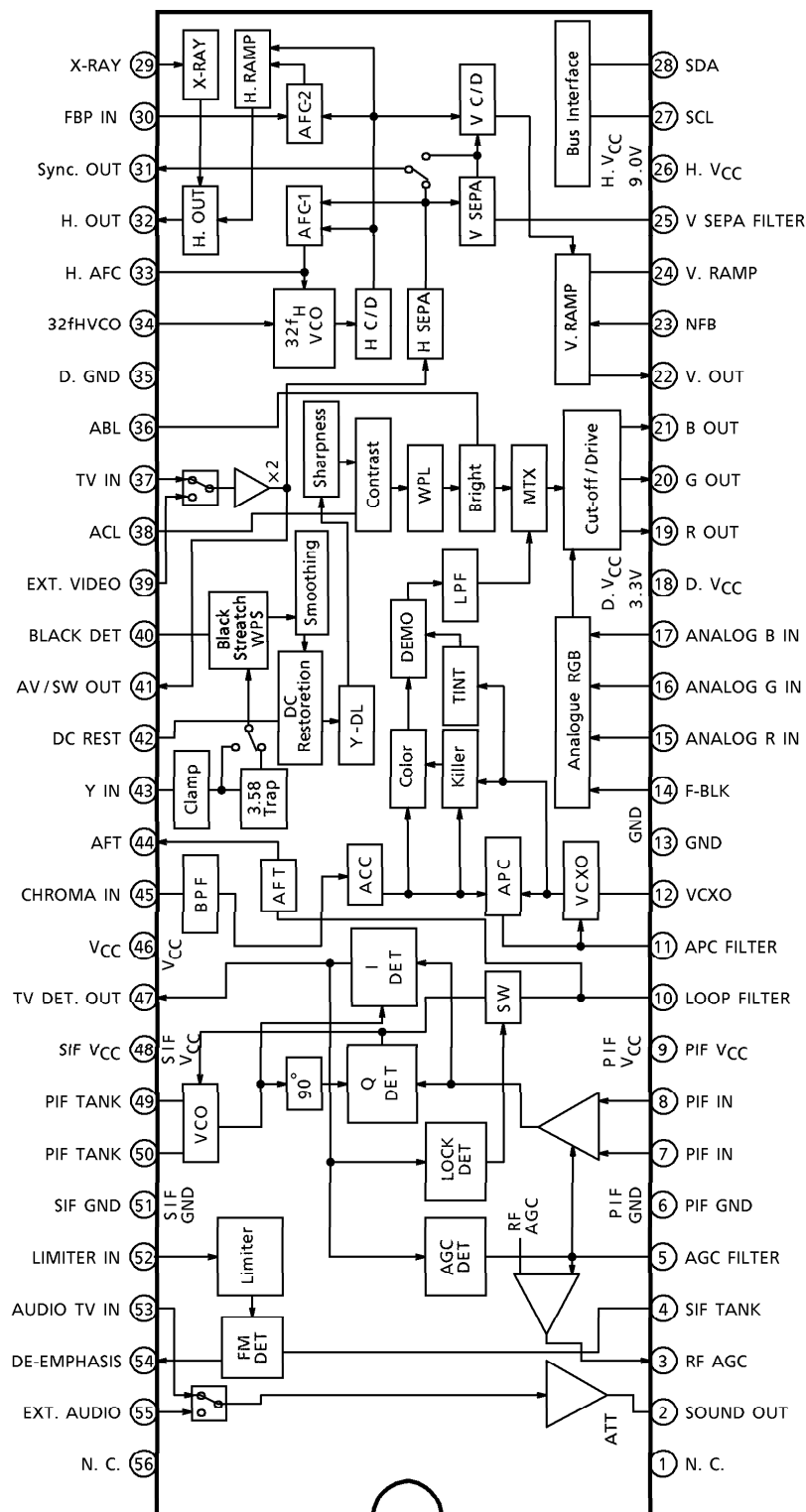
Deflection Circuit

- Auto-slicer Type High Performance Sync. Separation Circuit
- Adjustment Free Countdown System
- Sync. Separation Output
- X-ray Protect Circuit
- Vertical Ramp Output
- Dual Time Constant AFC Circuit
- Horizontal and Vertical Position Adjustment (Bus adjustment)
- Vertical Amplitude Adjustment (Bus adjustment)



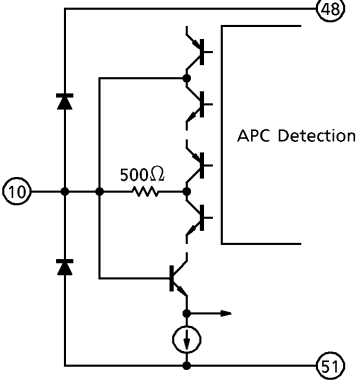
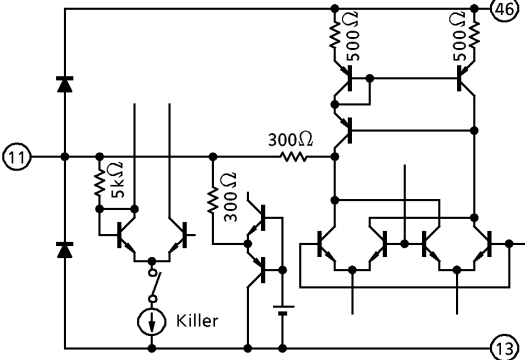
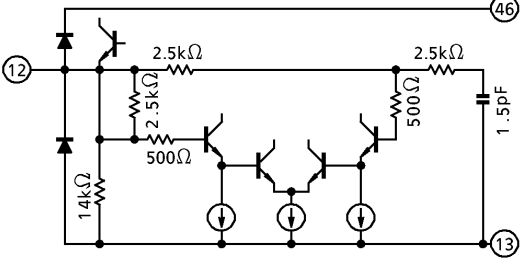
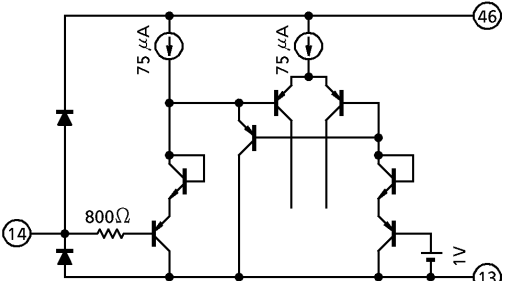
Weight : 5.55g (Typ.)

BLOCK DIAGRAM



TERMINAL FUNCTION

PIN No.	PIN NAME	FUNCTION	INTERFACE CIRCUIT
2	Sound Output	This terminal is for Sound Output. The maximum flow out current of these terminals is 3.6mA. So, the minimum load resistor is 1k Ω .	
3	RF AGC	This terminal is for RF AGC output.	
4	SIF Tank Coil	This terminal is for connecting SIF detect tank coil. This terminal is for Sound Mute Switch, too. If this terminal is connected to GND, the sound output is muted.	
5	AGC Filter	This terminal is for PIF 2nd AGC filter.	
6	PIF GND	This terminal is for GND of PIF circuit.	—
7 8	PIF Input	This terminal is for IF input. The typical input value is 90dB μ V.	

PIN No.	PIN NAME	FUNCTION	INTERFACE CIRCUIT
9	PIF V _{CC}	This terminal is for V _{CC} of PIF circuit.	—
10	Loop Filter	This terminal is for PIF PLL loop filter.	
11	APC Filter	This terminal is for APC filter of f _{sc} oscillation.	
12	VCXO	This terminal is for X'tal of 3.58MHz VCXO.	
13	GND	This terminal is for V/C/D GND.	—
14	Fast Blanking	This terminal is for fast blanking of RGB input.	

PIN No.	PIN NAME	FUNCTION	INTERFACE CIRCUIT
15 16 17	Analog RGB Input	These terminals are for RGB signal input.	
18	Digital VCC	This terminal is for VCC of digital circuit.	—
19 20 21	RGB Output	These terminals are for RGB primary color signal output.	
22	Vertical Output	This terminal is for vertical pulse output.	
23 24	NFB, Vertical Ramp.	These terminals are for NFB input and vertical ramp output.	

PIN No.	PIN NAME	FUNCTION	INTERFACE CIRCUIT
25	Vertical Sync. Separation Filter	This terminal is for vertical sync. separation filter.	
26	H. VCC	This terminal is for VCC of horizontal circuit.	—
27 28	SCL, SDA	These terminals are for input and output of I ² C Bus.	
29	X-RAY	This terminal is for input of X-RAY protect circuit. The threshold voltage is 3.5V (Typ.). If this terminal is applied the voltage that is more than threshold voltage, the X-RAY protect circuit make horizontal output a low.	
30	Fly-back Pulse Input	This terminal is for Fly-back Pulse input. The Fly-back Pulse is the reference of AFC circuit, gate pulse and so on. The current needs to keep under 1mA.	* Fly-back Pulse Phase
31	Sync. Pulse Output	This terminal is for Sync. pulse output.	

PIN No.	PIN NAME	FUNCTION	INTERFACE CIRCUIT
32	Horizontal Output	This terminal is for horizontal pulse output.	
33	H. AFC	This terminal is for horizontal AFC filter. The AFC circuit fits the phase between inputted horizontal sync. signal and horizontal pulse which is made by countdowning 32f _H .	
34	32f _H VCO	This terminal is for connecting ceramic oscillator. That constitutes 32f _H (503kHz) oscillation circuit. The CSBLA503KECZF30 (Murata) is recommended.	
35	D. GND	This terminal is for GND of digital circuit.	—
36	A.B.L.	This terminal is for A.B.L. circuit.	
37	TV Input	This terminal is for input of PIF detected signal. The typical input amplitude is 1.0V _{p-p} .	

PIN No.	PIN NAME	FUNCTION	INTERFACE CIRCUIT
38	A.C.L.	This terminal is for ACL circuit.	
39	External Video Input	This terminal is for input of external video signal.	
40	Black Peak Detection	This terminal is for filter of black peak detection.	
41	Video Switch Output	This terminal is for output of video switch which selects TV signal or external video. Amp. Gain ; Min. 1.7 Typ. 1.9, Max. 2.1	
42	D.C. Restoration	This terminal is for filter of APL detection.	

PIN No.	PIN NAME	FUNCTION	INTERFACE CIRCUIT															
43	Y Input	This terminal is for Y signal input. The typical input amplitude is 1.0V_{p-p}.																
44	A.F.T.	This terminal is for AFT output. Monitor signal output mode can be selected via Bus. <table border="1"><thead><tr><th>B₀</th><th>B₁</th><th>OUTPUT</th></tr></thead><tbody><tr><td>0</td><td>0</td><td>AFT</td></tr><tr><td>0</td><td>1</td><td>TEST purpose only</td></tr><tr><td>1</td><td>0</td><td>B</td></tr><tr><td>1</td><td>1</td><td>RFAGC / 2</td></tr></tbody></table>	B ₀	B ₁	OUTPUT	0	0	AFT	0	1	TEST purpose only	1	0	B	1	1	RFAGC / 2	
B ₀	B ₁	OUTPUT																
0	0	AFT																
0	1	TEST purpose only																
1	0	B																
1	1	RFAGC / 2																
45	Chroma Input	This terminal is for chrominance signal input. The typical input signal amplitude is 286mV_{p-p} (at burst signal). This IC is to go to test mode with this terminal voltage higher than 4.5V.																
46	V/C/D V _{CC}	This terminal is for V _{CC} of video, Chroma and Deflection circuit.	—															
47	TV Detection Output	This terminal is for PIF detected signal output.																
48	S.I.F. V _{CC}	This terminal is for V _{CC} of SIF circuit.	—															

PIN No.	PIN NAME	FUNCTION	INTERFACE CIRCUIT
49 50	P.I.F. Tank Coil	These terminals are for connecting a tank coil of PIF detection circuit. TOKO Corp. products 292GJAS-7475BS (45.75MHz), 292GJAS-7476BS (58.75MHz) are recommended.	
51	S.I.F. GND	This terminal is for GND of SIF circuit.	—
52	Limiter Input	This terminal is for input of SIF limiter amplifier circuit.	
53	TV Audio Signal Input	This terminal is for input of SIF detected signal. This terminal is connected to pin 54 via capacitor.	
54	De-emphasis	This terminal is for filter of SIF de-emphasis.	
55	External Audio Input	These terminals are for external audio input.	

Slave address : 88H

SUB ADDRESS	D7	D6	D5	D4	D3	D2	D1	D0	PRESET		
00	Trap	Color							0000	0000	
01	C. Filter	Tint							1100	0000	
02	A. SW	Brightness							0000	0000	
03	BLK	Uni-color							0000	0000	
04	Mute		Sharpness						0110	0000	
05	Vertical Phase			Horizontal Phase						0001	0000
06	B ₀	B ₁	Audio Attenuator						0000	0000	
07	B ₂	B ₃	DON'T USE (Fix on 100000)						0010	0000	
08	B ₄	V. SW	RF AGC						0000	0000	
09	AFC	WPL	Vertical Amplitude						0010	0000	
0A	V. Fixed	PIF VCO						0100	0000		
0B	R Cut Off							0000	0000		
0C	G Cut Off							0000	0000		
0D	B Cut Off							0000	0000		
0E	G Gain							0000	0000		
0F	B Gain							0000	0000		

FUNCTION	RANGE (MIN.~MAX.)	DEFAULT
Color	- 60~0dB	- 60dB
TINT	± 42°	0°
Brightness	1.34~2.6~3.86V	1.34V
Uni-Color	- 24~0dB	- 24dB
Sharpness	- 18~6dB~14dB (4MHz Gain)	6dB
Audio ATT	- 85~6dB	- 85dB
RF AGC	65dB μ ~105dB μ V (0.6dB / bit), 000000 : IF Mute	IF Mute
Ver. Amplitude	1.6~2.4V	Center
PIF VCO	± 2.2MHz (35kHz / bit)	Center
RGB Cut-off	- 0.4~0.4V	- 0.4V
GB Gain	- 3.1~3.1dB	- 3.1dB

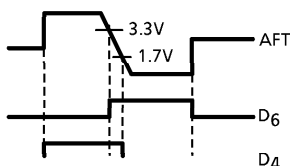
FUNCTION	RANGE (MIN.~MAX.)	DEFAULT
3.58 Trap	(0) : On / (1) : Off	On
Chroma Filter	(0) : Band Pass Filter / (1) : Take Off Filter	TOF
A, V SW	(0) : TV Mode / (1) : EXT. Mode	TV
BLK	(0) : BLK On / (1) : BLK Off	On
MUTE	(00) : Off / (01) : Y MUTE / (10) : Hout Stop / (11) : Y MUTE + V Stop	(01)
H. AFC	(0) : AFC2 Normal / (1) : AFC2 × 3	(0)
WPL	(0) : On / (1) : Off	Off
V. Fixed Mode	(0) : Normal / (1) : V Frequency 60Hz Fix	Normal
B ₀ , B ₁ (Monitor)	Pin 44's output is selectable. (00) : AFT Voltage / (01) : Test Mode / (10) : Blue Output / (11) : Half of RF AGC Voltage	AFT Voltage
B ₂ , B ₃ , B ₄ (Test Mode)	Bits for Test Mode. Use this IC with these bits (000).	(000)

Read Mode

D7	D6	D5	D4	D3	D2	D1	D0
POR	AFT	IF Lock	AFT	Killer	V Lock	H Lock	X-RAY

FUNCTION	CONTENTS
POR (Power On Reset)	(0) : SECOND / (1) : FIRST
AFT	Refer to Following Figure
IF LOCK	(0) : LOCK OUT / (1) : LOCK IN
Killer	(0) : Killer ON / (1) : Killer OFF
V LOCK	(0) : LOCK IN / (1) : LOCK OUT Det. Window : 262H~263H
H LOCK	(0) : LOCK OUT / (1) : LOCK IN This function is forced to unlock at V _p , so data is valid after 50H.
X-RAY	(0) : X-RAY OFF / (1) : X-RAY ON

- Vertical Phase (3bit)
This mode is for changing vertical output timing.
(Vertical picture position is changed 0~7H as right Table.)
- Horizontal Phase (5bit)
This mode is for changing horizontal picture position.
Horizontal output phase is changed $\pm 3\mu\text{s}$ as maximum.
- AFT Read Bus

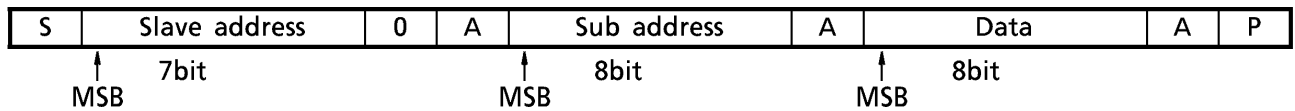


D7	D6	D5	MODE
0	0	0	Reference
0	0	1	1H Delay
0	1	0	2H Delay
0	1	1	3H Delay
1	0	0	4H Delay
1	0	1	5H Delay
1	1	0	6H Delay
1	1	1	7H Delay

I²C BUS CONTROLLED FORMAT SUMMARY

Bus controlled format of TA1268N is based on I²C Bus Control format of Philips.

Data Transfer Format

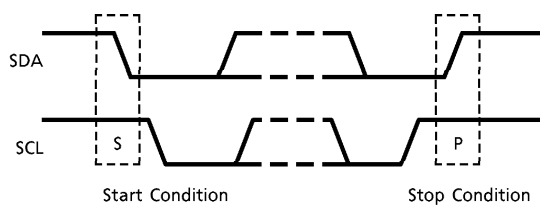


S : Start Condition

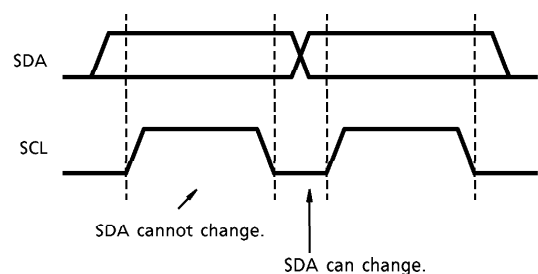
P : Stop Condition

A : Acknowledge

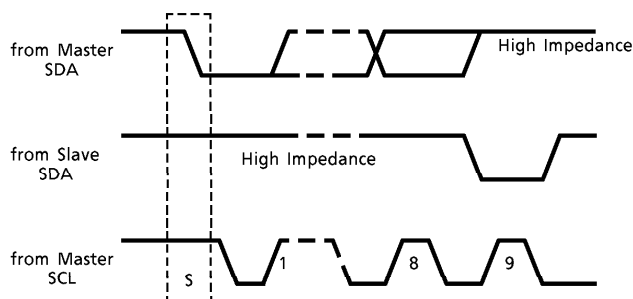
(1) Start and Stop Condition



(2) Bit Transfer



(3) Acknowledge



(4) Slave Address

A6	A5	A4	A3	A2	A1	A0	R/ $\overline{W}$
1	0	0	0	1	0	0	0

Purchase of TOSHIBA I²C components conveys a license under the Philips I²C Patent Rights to use these components in an I²C system, provided that the system conforms to the I²C Standard Specification as defined by Philips.

MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Power Supply Voltage	V _{CC}	12	V
Power Dissipation	P _{Dmax}	2.19 (Note 1)	W
Input Terminal Voltage	V _{in}	GND – 0.3~V _{CC} + 0.3	V
Input Signal Amplitude	e _{in}	4	V _{p-p}
Operating Temperature	T _{opr}	– 20~65	°C
Storage Temperature	T _{stg}	– 55~150	°C

(Note 1) When using the device at above Ta = 25°C, decrease the power dissipation by 17.5mW for each increase of 1°C.

(Note 2) As this IC is weak in a surge voltage, handle it with care from being damage.

RECOMMENDED OPERATING CONDITION

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	REMARKS
PIF Power Supply Voltage	V _{CCP}	8.5	9.0	9.5	V	—
SIF Power Supply Voltage	V _{CCS}	8.5	9.0	9.5	V	—
V/C/D Power Supply Voltage	V _{CCV}	8.5	9.0	9.5	V	—
H.V _{CC} Power Supply Voltage	H.V _{CC}	8.5	9.0	9.5	V	—
D.V _{CC} Power Supply Voltage	D.V _{CC}	2.7	3.3	3.8	V	—
TV External Video Input Level	V _{in37/39}	—	1.0	—	V _{p-p}	including sync.
Standard Video Input Level	V _{in43}	—	1.0	—	V _{p-p}	including sync.
Standard Chroma Input Level	V _{in45}	—	286	—	mV _{p-p}	at burst signal
FBP Width	T _{FBP}	10	12	—	μs	V _{th} = 1.4V, V _{CC} – 1.4V
FBP Input Flow In Current	I _{FBPmax}	—	—	2	mA	—
PIF Output Load Resister	R _{OP}	2	8.2	—	kΩ	—
SIF Output Load Resister	R _{OS}	1	8.2	—	kΩ	—
RGB Output Load Resister	R _{ORGB}	—	1.8	—	kΩ	—
Horizontal Output Load Resister	R _{HOUT}	330	800	—	Ω	maximum 10mA
Vertical Output Load Resister	R _{VOOUT}	4.1	5.7	—	kΩ	—
Sync. Separation Output Flow In Current	I _{syncmax}	—	—	1	mA	—

ELECTRICAL CHARACTERISTICSDC characteristics (Unless Otherwise Specified, $V_{CC} = 9V$, H. $V_{CC} = 9V$, $T_a = 25^\circ C$)

PIN No.	CHARACTERISTIC	SYMBOL	TEST CIR-CUIT	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
2	Sound Output	V_2	—	—	3.20	3.70	4.20	V
3	RF AGC	V_3	—	—	—	0.00	0.50	V
5	AGC Filter	V_5	—	—	7.00	7.50	8.00	V
6	PIF GND	GND	—	—	—	0.00	—	V
7	PIF Input	V_7	—	—	1.50	2.00	2.50	V
8	PIF Input	V_8	—	—	—	0.00	0.50	V
9	PIF V_{CC}	V_{CC}	—	—	—	9.00	—	V
10	Loop Filter	V_{10}	—	—	—	4.50	—	V
11	APC Filter	V_{11}	—	—	6.00	6.50	7.00	V
12	VCXO	V_{12}	—	—	5.30	5.80	6.30	V
13	V/C/D GND	GND	—	—	—	0.00	—	V
14	F-BLK	V_{14}	—	—	—	0.00	—	V
15	Analog R Input	V_{15}	—	—	4.40	4.90	5.40	V
16	Analog G Input	V_{16}	—	—	4.40	4.90	5.40	V
17	Analog B Input	V_{17}	—	—	4.40	4.90	5.40	V
18	D. V_{CC}	V_{CC}	—	—	—	3.30	—	V
19	R Output	V_{19}	—	BRT, C. O Cent	2.40	2.70	2.90	V
20	G Output	V_{20}	—	BRT, C. O Cent	2.40	2.70	2.90	V
21	B Output	V_{21}	—	BRT, C. O Cent	2.40	2.70	2.90	V
25	V SEPA	V_{25}	—	—	5.80	6.30	6.80	V
26	H. V_{CC}	V_{26}	—	—	—	9.00	—	V
27	SCL	V_{27}	—	—	4.50	5.00	5.50	V
28	SDA	V_{28}	—	—	4.50	5.00	5.50	V
29	X-RAY	V_{29}	—	—	—	0.00	—	V
33	H. AFC	V_{33}	—	—	7.00	7.50	8.00	V
34	$32f_H$ VCO	V_{34}	—	—	5.50	6.00	6.50	V
35	D. GND	GND	—	—	—	0.00	—	V
36	ABL	V_{36}	—	BRT, COL Cent	2.90	3.40	3.90	V
37	TV Input	V_{37}	—	—	2.90	3.00	3.90	V
38	ACL	V_{38}	—	BRT, COL Cent	2.90	3.40	3.90	V

PIN No.	CHARACTERISTIC	SYMBOL	TEST CIR-CUIT	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
39	EXT. Video Input	V ₃₉	—	—	1.10	1.60	2.10	V
40	Black DET	V ₄₀	—	—	6.10	6.60	7.10	V
41	AV / SW Output	V ₄₁	—	—	1.80	2.30	2.80	V
42	DC Rest	V ₄₂	—	—	5.50	6.00	6.50	V
43	Y Input	V ₄₃	—	—	4.00	4.50	5.00	V
44	AFT	V ₄₄	—	—	2.00	2.50	3.00	V
45	Chroma Input	V ₄₅	—	—	1.60	1.85	2.10	V
46	V / C / D V _{CC}	V ₄₆	—	—	—	9.00	—	V
47	TV DET. Output	V ₄₇	—	—	4.70	5.20	5.70	V
48	SIF V _{CC}	V _{CC}	—	—	—	9.00	—	V
51	SIF GND	V _{CC}	—	—	—	0.00	—	V
52	Limiter Input	V ₅₂	—	—	—	0.00	0.50	V
53	Audio TV Input	V ₅₃	—	—	2.50	3.00	3.50	V
54	De-emphasis	V ₅₄	—	Pin 4 GND	4.00	4.50	5.00	V
55	EXT. Audio Input	V ₅₅	—	—	2.50	3.00	3.50	V

Current Consumption

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
IF Power Supply Current	I _{cci}	—	32.8	46	52.0	mA
V / C / D Power Supply Current	I _{ccv}	—	52.7	71	76.8	mA
H. V _{CC} Power Supply Current	I _{cch}	—	10.7	14	18.4	mA
D. V _{CC} Power Supply Current	I _{ccd}	—	5.2	10	11.6	mA

AC characteristics (Unless Otherwise Specified, $V_{CC} = 9V$, H. $V_{CC} = 9V$, $T_a = 25^\circ C$)

PIF

CHARACTERISTIC	SYMBOL	TEST CIR- CUIT	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Video Detected Output Level	V ₀₁	—	(Note 1)	1.7	2.0	2.3	V _{p-p}
	V ₀₂			2.0	2.5	3.0	
Input Sensitivity	V _{IN MIN}	—	(Note 2)	—	42	—	dB μ V
	V _{IN MAX}			100	107	—	
Sync Tip Level	V _{SYNC}	—	(Note 3)	2.6	2.9	3.2	V
Output Level For No Input	V _{IF}	—	(Note 4)	4.8	5.2	5.6	V
Differential Gain	DG	—	(Note 5)	—	2	5	%
Differential Phase	DP			—	2	5	°
PIF Output Frequency Characteristic	f _c	—	(Note 6)	5	7	—	MHz
Carrier Wave Compression Ratio	CR	—	(Note 7)	50	55	—	dB
2nd Harmonics Compression Ratio	HR			50	55	—	
PIF Input Resistance	R _{iPIF}	—	(Note 8)	—	1.5	—	k Ω
PIF Input Capacitance	C _{iPIF}			—	3.8	—	pF
S / N	S / N	—	(Note 9)	52	55	—	dB
920kHz Beat	I ₉₂₀	—	(Note 10)	42	45	—	dB
IF AGC Range	RW _{AGC}	—	(Note 11)	61	65	69	dB
IF AGC Voltage	V _{5MEAN}	—	(Note 12)	4.2	4.5	4.8	V
	V _{5MAX}			7.4	7.6	—	
	V _{5MIN}			—	3.8	—	
RF AGC Voltage	V _{3MAX}	—	(Note 13)	7.7	8.2	—	V
	V _{3MIN}			—	0	0.5	
RF AGC Control Range	Δ GrFAGC	—	(Note 14)	35	40	—	dB
AFT Center Voltage	V _{4CENT}	—	(Note 15)	2.2	2.5	2.8	V
AFT Voltage	V _{4MAX}	—	(Note 16)	4.4	4.8	—	V
	V _{4MIN}			—	0.2	0.5	
AFT Sensitivity	μ AFT	—	(Note 17)	—	40	—	kHz / V
AFT Output Resistance	R _{AFTOUT}	—	(Note 18)	40	50	60	k Ω
PIF VCO Control Sensitivity	β _{IFVCO}	—	(Note 19)	2.0	2.5	—	MHz / V
PIF VCO Pull-in Range	f _{ph}	—	(Note 20)	1.0	1.5	—	MHz
	f _{pl}			1.0	1.5	—	
PIF VCO Control Range	Δ f _{PIFVCO}	—	(Note 21)	—	4.4	—	MHz

SIF

CHARACTERISTIC	SYMBOL	TEST CIR- CUIT	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Sound Output Level	V _{AAC}	—	(Note 22)	400	500	600	mV _{rms}
	V _{ADC}			—	4.5	—	V
Sound Distortion	V _{AUDIO}	—	(Note 23)	—	0.3	1.0	%
AMR	AMR	—	(Note 24)	50	60	—	dB
Limiting Sensitivity	V _{LIM}	—	(Note 25)	—	35	—	dB μ V
Sound Output Frequency Characteristics	f _{AUDIOH}	—	(Note 26)	—	130	—	kHz
	f _{AUDIOL}			—	— 130	—	
Sound Output Resistance	R _{SOUT}	—	(Note 27)	24	30	36	k Ω

ATT

ATT Gain	G _{ATTMAXE}	—	(Note 28)	— 2.0	0.0	2.0	dB
	G _{ATTMAXT}			4.0	6.0	8.0	
	G _{ATTMEAN}			— 16	— 12	— 9	
	G _{ATTMIN}			— 99	— 85	—	
DC Voltage Drift	V _{2VAR}	—	(Note 29)	—	—	50	mV
	V _{2DC}			3.2	3.7	4.2	V
Input Impedance	R _{i53}	—	(Note 30)	—	30	—	k Ω
	R _{i55}			—	47	—	

Video

Input Impedance	R _{i41}	—	(Note 31)	100	—	—	k Ω
Input Dynamic Range	V _{di41}	—	(Note 32)	1.0	1.2	1.5	V
Video Total Gain	G _Y	—	(Note 33)	4.5	5.0	—	
Video Frequency Characteristic	f _Y	—	(Note 34)	6.0	7.0	—	MHz
Maximum Output	V _{do1}	—	(Note 35)	7.5	8.0	—	V
Black Expansion Amp. Gain	G _{BAMP}	—	(Note 36)	1.18	1.43	1.68	
Black Expansion Start Point	G _{BSTP}			40	50	60	
DC Restoration	T _{DC}	—	(Note 37)	100	103	105	%
Sharpness Control Characteristics	G _{SHcent}	—	(Note 38)	1	4	7	dB
	G _{SHmax}			9	12	15	
	G _{SHmin}			—	— 18	— 15	
Sharpness Delay Time	t _{SHDLY}	—	(Note 39)	—	125	—	ns
Contrast Control Characteristics	G _{CNcent}	—	(Note 40)	4.5	6	7.5	dB
	G _{CNmin}	—		22.5	24	28.5	
H. V-BLK Output Voltage	V _{BLK}	—	(Note 41)	—	0.7	1.0	V
V-BLK Width	T _{VBLK}	—	(Note 42)	—	3.5~24	—	H
f _{sc} Trap Gain	G _{TRAP}	—	(Note 43)	—	— 28	— 20	dB

OSD

CHARACTERISTIC	SYMBOL	TEST CIR- CUIT	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
OSD Switching Voltage	V_{thOSD}	—	(Note 44)	0.7	1.0	1.3	V
OSD Delay Time	t_{OSDDL}	—	(Note 45)	—	15	30	ns
OSD Delay Time Difference	t_{OSDD}			—	5	10	
OSD Rising Time	τ_R			—	15	30	
OSD Falling Time	τ_F			—	15	30	
Input Clamp Voltage	V_{OSDC}	—	(Note 46)	4.4	4.9	5.4	V
OSD Gain	G_{OSD}	—	(Note 47)	1.8	2.0	2.2	
Input Dynamic Range	V_{diOSD}		(Note 48)	2.0	2.2	2.4	V

Cutoff Drive

Brightness Control Characteristics	V_{BRTmax}	—	(Note 49)	3.6	4.0	4.3	V
	V_{BRTcen}			2.4	2.7	3.0	
	V_{BRTmin}			1.0	1.4	1.7	
Brightness Control Difference Between 3Axes	ΔV_{RGB}	—	(Note 50)	− 50	0	50	mV
Cutoff Control Characteristics	V_{cutmax}	—	(Note 51)	0.5	0.65	0.8	V
	V_{cutcen}			—	0.00	—	
	V_{cutmin}			− 0.8	− 0.65	− 0.5	
Drive Control Characteristics	G_{drvmax}	—	(Note 52)	3.75	4.25	4.75	dB
	G_{drvmin}			− 4.0	− 3.5	− 3.0	

Chroma

Input Dynamic Range	V_{di45}	—	(Note 53)	0.95	1.5	1.7	V
ACC Characteristic	ea	—	(Note 54)	− 23	− 20	− 17	dB
	eb			3	6	9	
	A			0.9	1.0	1.1	
Killer Point	EK	—	(Note 55)	− 48	− 46	− 43	dB
VCXO Frequency Control Range	Δf_{VCXO}	—	(Note 56)	± 500	± 600	—	Hz
VCXO Frequency Control Sensitivity	β_{VCXO}	—	(Note 57)	—	1.0	—	Hz / mV
VCXO Pull-in Range	f_{VCXOPL}	—	(Note 58)	± 300	± 450	—	Hz
Demodulate Relative Gain	R / B	—	(Note 59)	0.78	0.83	0.88	°
	G / B			0.31	0.35	0.39	
Demodulate Relative Phase	R-B			84	91	98	
	G-B			233	240	247	
Carrier Wave Remain	E_{CR}	—	(Note 60)	—	20	40	mV _{p-p}
	E_{CB}			—	20	40	
	E_{CG}			—	20	40	

CHARACTERISTIC	SYMBOL	TEST CIRCUIT	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Color Control Characteristic	V_{CLRmax}	—	(Note 61)	3.9	4.1	4.3	V_{p-p}
	G_{CLRcen}			4.5	6	7.5	dB
	G_{CLRmin}			38	40	—	
Uni-color Control Characteristic	G_{UNlcn}	—	(Note 62)	4.5	6	7.5	dB
	G_{UNlmin}			22	24	26	
TINT Control Characteristic	θ_{TNTcen}	—	(Note 63)	-7	0	7	°
	$\Delta\theta_{TNT}$			± 35	± 45	± 55	
Video Chroma Delay Time	t_{V-C}	—	(Note 64)	-30	0	30	ns

Deflection

Horizontal Free Run Freq.	f_H	—	(Note 65)	-100	0	100	Hz
H. Out Pulse Duty	T_H	—	(Note 66)	38	41	44	%
H. Out Voltage	V_{HL}	—	(Note 67)	—	0.2	0.3	V
	V_{HH}			2.5	3.0	3.5	
VCO Osc. Start Voltage	V_{OSCmin}	—	(Note 68)	3.0	3.5	4.0	V
H. Out Start Voltage	V_{HST}	—	(Note 69)	3.7	4.0	—	V
H. Frequency Control Range	Δf_H	—	(Note 70)	± 500	± 650	—	Hz
H. Freq. Control Sensitivity	β_H	—	(Note 71)	—	500	—	Hz / V
H. Sync. Pull-in Range	Δf_{HPUL}	—	(Note 72)	± 450	± 500	—	Hz
H. Pull-in Stop Period	T_{HSTP}	—	(Note 73)	—	259 ~272	—	H
AFC-2 Control Range	T_{AFC2}	—	(Note 74)	16	17	—	μs
Horizontal Position Adjustment	T_{PAFC2}	—	(Note 75)	—	± 3	—	μs
X-RAY Protection Detection Voltage	V_{XDET}	—	(Note 76)	3.35	3.5	3.65	V
X-RAY Protection Hold Voltage	V_{XHLD}			3.9	4.2	4.5	
X-RAY Protection Hold Current	V_{XLD}			80	100	120	μA
Vertical Free Run Freq.	f_V	—	(Note 77)	—	295	—	H
V. Sync. Pull-in Range	T_{VST}	—	(Note 78)	—	224	—	H
	T_{VEND}			—	295	—	
V. Out Pulse Width	T_V	—	(Note 79)	—	8	—	H
V. Ramp Amplitude Control	V_{VL}	—	(Note 80)	2.2	2.4	—	V
	V_{VH}			—	1.6	1.8	
H. Sync. Separation Level	R_{sepa}	—	(Note 81)	30	35	40	%
Forced V. Osc. (262.5H)	f_{V60}	—	(Note 82)	—	60	—	Hz

TEST CONDITION

NOTE	ITEM	TEST CONDITION (V _{CC} = 9V, T _a = 25±3°C)				MEASUREMENT METHOD
		BUS MODE				
		(06)	(07)	(08)	(0A)	
1	Video Detected Output Level	(00)	(20)	(20)	—	(1) Apply the IF signal. (f ₀ = 45.75MHz, 87.5% AM, 31.6mV _{rms}) to IF input. (2) Measure the output signal level at pin 47. (V _{O1}) (3) Apply the signal (100% AM, 31.6mV _{rms}) to IF input. (4) Measure the output signal level pin 47. (V _{O2}) 
2	Input Sensitivity	↑	↑	↑	↑	(1) Apply the signal (f ₀ = 45.75MHz, 30% AM, 31.6mV _{rms}) to IF input. (2) Decrease input signal level. Measure the input signal level at IF input, when output signal level at pin 47 decreases as -3dB level. (V _{IN MIN}) (3) Increase input signal level. Measure the input signal level at IF input, when output signal level at pin 47 increases as +0.5dB level. (V _{IN MAX})
3	Sync. Tip Level	↑	↑	↑	↑	(1) Apply the signal (f ₀ = 45.75MHz, 31.6mV _{rms} , Non modulation) to IF input. (2) Measure the DC voltage at pin 47 (V _{SYNC})
4	Output Level for No Input	↑	↑	↑	↑	(1) Non IF input (2) Apply 3.0V at pin 5. (3) Measure the DC voltage at pin 47. (V _{IF})
5	Differential Gain Differential Phase	↑	↑	↑	↑	(1) Apply the IF signal (f ₀ = 45.75MHz, 87.5% AM Video) to IF input. (2) Measure the differential gain and phase at pin 47.

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NOTE	ITEM	TEST CONDITION (V _{CC} = 9V, T _a = 25±3°C)				MEASUREMENT METHOD
		BUS MODE				
		(06)	(07)	(08)	(0A)	
6	PIF Output Frequency Characteristics	(00)	(20)	(20)	—	(1) Same as Note 3 (1) (2) Fix the voltage at pin 5. (3) Apply the signal as follows to IF input, f ₀ = 45.75MHz 31.6mV _{rms} f ₁ = 45.65~32MHz 3.16mV _{rms} (4) Measure f ₁ frequency, when the output level at pin 47 becomes -3dB. f _c = f ₀ - f ₁
7	Carrier Wave Compression Ratio 2nd Harmonics Compression Ratio	↑	↑	↑	↑	(1) Apply the signal (f ₀ = 45.75MHz, f _m = 15.75kHz, 78% AM, 31.6mV _{rms}) to IF input. (2) Apply the voltage at pin 5 so that output level of pin 47 becomes 2V _{p-p} . (3) Measure the leak level of carrier wave at pin 47 when non modulation IF signal is inputted. CR = 20log (2 (V _{p-p}) / the leak level of carrier wave (mV _{rms})) (4) Measure the leak level of 2nd harmonics in the same way. HR = 20log (2 (V _{p-p}) / the leak level of 2nd harmonics (mV _{rms}))
8	PIF Input Resistance PIF Input Capacitance	↑	↑	↑	↑	(1) Apply 3.0V to pin 5. (2) Measure the impedance between pin 7 and 8.
9	S / N	↑	↑	↑	↑	(1) Same as Note 2 (1) (2) Measure output level at pin 47 (VA) (3) Same as Note 3 (1) (4) Measure output level at pin 47 (VB) S / N = 20log (VA / VB × 6)

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NOTE	ITEM	TEST CONDITION (V _{CC} = 9V, T _a = 25±3°C)				MEASUREMENT METHOD
		BUS MODE				
		(06)	(07)	(08)	(0A)	
10	920kHz Beat	(00)	(20)	(20)	—	(1) Apply the signals as follows to IF input, f ₀ = 45.75MHz 31.6mV _{rms} f _c = 42.17MHz 10.0mV _{rms} f ₅ = 41.25MHz 10.0mV _{rms} (2) Apply the voltage so that the lowest of the output at pin 47 is equal V _{sync} .  (3) Measure the difference between f _c and 920kHz beat.
11	IF AGC Range	↑	↑	↑	↑	RW _{AGC} = V _{INMAX} - V _{INMIN}
12	IF AGC Voltage	↑	↑	↑	↑	(1) Same as Note 3 (1) (2) Measure the voltage at pin 5. (V _{5MEAN}) (3) Measure the voltage at pin 5 when no input. (V _{5MAX}) (4) Measure the voltage at pin 5 when input signal level is 178mV _{rms} (V _{5MIN}).
13	RF AGC Voltage	↑	↑	Ad-just	↑	(1) Same as Note 3 (1) (2) Adjust the data of sub-address (08) (RF AGC) so that the voltage at pin 3 become 4.5V. (3) Measure the voltage at pin 3 when no input. (V _{3MAX}) (4) Measure the voltage at pin 3 when input signal level is 178mV _{rms} (V _{3MIN}).

NOTE	ITEM	TEST CONDITION (V _{CC} = 9V, Ta = 25±3°C)					MEASUREMENT METHOD
		BUS MODE					
		(06)	(07)	(08)	(0A)		
14	RF AGC Control Range	(00)	(20)	Ad-just	—		(1) Same as Note 3 (1) (2) Set the data of sub-address (08) to (00). Decrease the IF input level. Measure the IF input level, when the voltage of pin 3 become 4.5V. (V _{RFMIN}) (3) Set the data of sub-address (08) to (3F). Measure the IF input level, when the voltage of pin 3 become 4.5V. (V _{RFMAX}) ΔV _{RFAGC} = V _{RFMIN} —V _{RFMAX}
15	AFT Center Voltage	↑	↑	(20)	↑		(1) No IF input (2) Apply 3.0V to pin 5. (3) Measure the voltage at pin 44. (V _{4CENT})
16	AFT Voltage	↑	↑	↑	↑		(1) Apply the signal (f = 44.75MHz, 30% AM Video, 31.6mV _{rms}) to IF input. (2) Measure the output signal level at pin 44. (V _{4MAX}) (3) Apply the signal (f = 46.75MHz, 30% AM Video, 31.6mV _{rms}) to IF input. (4) Measure the output signal level at pin 4. (V _{4MIN})
17	AFT Sensitivity	↑	↑	↑	↑		(1) Same as Note 3 (1) (2) Measure the voltage change at pin 44 when input frequency is changed. (Δf / ΔV)
18	AFT Output Resistance	↑	↑	↑	↑		Measure the output impedance of pin 44.

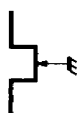
NOTE	ITEM	TEST CONDITION (V _{CC} = 9V, T _a = 25±3°C)				MEASUREMENT METHOD
		BUS MODE				
		(06)	(07)	(08)	(0A)	
19	PIF VCO Control Sensitivity	(00)	(20)	(20)	—	(1) Apply the signal (f = 45.75MHz, 31.6mV _{rms} , CW) to IF input. (2) Measure the DC voltage at pin 10. (V10A) (3) Apply the signal (f = 45.55MHz, 31.6mV _{rms} , CW) to IF input. (4) Measure the DC voltage at pin 10. (V10B) $\beta_{IFVCO} = 0.2 \text{ (MHz)} / (V10B - V10A) \text{ (V)}$ [MHz / V]
20	PIF VCO Pull-in Range	↑	↑	↑	↑	(1) Apply the signal (f = 45.75MHz, 31.6mV _{rms} , CW) to IF input. (2) Observe output signal at pin 47 and change the IF input frequency from higher to lower. Measure the IF input frequency when PLL is locked. Calculate the frequency difference between above frequency and 45.75MHz. (fph) (3) Observe output signal at pin 47 and change the IF input frequency from lower to higher. Measure the IF input frequency when PLL is locked. Calculate the frequency difference between above frequency and 45.75MHz. (fpl)
21	PIF VCO Control Range	↑	↑	↑	Adjust	(1) No IF input. (2) Apply 3.0V to pin 5. (3) Measure the frequency of PIF VCO when the data of sub-address (0A) is set (00) (f _{pfifmin}) (4) Measure the frequency of PIF VCO when the data of sub-address (0A) is set (7F) (f _{pfifmax})

NOTE	ITEM	TEST CONDITION (V _{CC} = 9V, T _a = 25±3°C)						MEASUREMENT METHOD
		BUS MODE						
		(06)	(07)	(08)	(0A)	SW52		
22	Sound Output Level	(00)	(20)	(20)	—	ON		(1) Apply the signal (f ₀ = 4.5MHz, f _m = 400Hz, 25kHz / devi FM, 100mV _{rms}) to pin 52. (2) Measure the output signal amplitude pin 54.
23	Sound Distortion	↑	↑	↑	↑	↑		(1) Same as Note 22 (1) (2) Measure the distortion of output signal at pin 54.
24	AMR	↑	↑	↑	↑	↑		(1) Apply the signals as follows to pin 52, FM : 400Hz 25kHz / devi FM, 100mV _{rms} AM : 400Hz 30% 100mV _{rms} (2) Measure the output level at pin 54 against each input. AMR = 20log (FM / AM)
25	Limiting Sensitivity	↑	↑	↑	↑	↑		(1) Same as Note 22 (1) (2) Change the input level. Measure the input level when the output level at pin 54 become —3dB.
26	Sound Output Frequency Characteristics	↑	↑	↑	↑	↑		(1) Same as Note 22 (1) (2) Change the input frequency. Measure the input frequency when the output level at pin 54 become — 3dB compare with peak level.
27	Sound Output Resistance	↑	↑	↑	↑	OFF		Measure the output impedance at pin 54.

NOTE	ITEM	TEST CONDITION (V _{CC} = 9V, T _a = 25±3°C)						MEASUREMENT METHOD
		BUS MODE						
		(02)	(06)	(07)	(08)	(0A)		
28	ATT Gain	(80)	Ad-just	(20)	(20)	—		(1) Apply the signal (1kHz, 500mV _{rms}) to pin 55. (2) Set the data of sub-address (02) to (80) (3) Measure the output level at pin 2 when the data of sub-address (06) is set to (3F) (VATTMAX) GATTMAX = 20log (VATTMAX / 500mV _{rms}) (4) Measure the output level at pin 2 when the data of sub-address (06) is set to (20) (VATTMAX) GATTMEAN = 20log (VATTMEAN / VATTMAX) (5) Measure the output level at pin 2 when the data of sub-address (06) is set to (00) (VATTMIN) GATTMIN = 20log (VATTMIN / VATTMAX)
29	DC Voltage Drift	↑	↑	↑	↑	↑	↑	(1) Same as Note 28 (1) (2) Same as Note 28 (2) (3) Measure the DC voltage at pin 2. (V _{2DC}) (4) Measure the voltage change at pin 2 when the data of sub-address (06) is changed from (20) to (00). (V _{2VAR})
30	Input Impedance	↑	(20)	↑	↑	↑	↑	Measure the input impedance of pin 53 and 55.

NOTE	ITEM	TEST CONDITION (V _{CC} = 9V, T _a = 25 ± 3°C)								MEASUREMENT METHOD
		BUS MODE								
		(00)	(02)	(03)	(04)	(0B)	(0C)	(0D)		
31	Input Impedance	(00)	(00)	(40)	(20)	(80)	(80)	(80)	Measure the input impedance of pin 37 and 39.	
32	Input Dynamic Range	↑	↑	↑	↑	↑	↑	↑	(1) TV Mode : Change the voltage in picture period at pin 37. External Mode : Change the voltage in picture period at pin 39. (2) Consider the change of R output as 100%. Measure the DC voltage at pin 19 when output level of pin 19 is 10% (V _{di1}). Measure the DC voltage at pin 41 when output level of pin 19 is 90% (V _{di2}). V _{di41} = V _{di2} - V _{di1}	
33	Video Total Gain	↑	↑	(7F)	↑	↑	↑	↑	(1) TV Mode : Apply the input signal 1 (f ₀ = 10kHz, 0.5V _{p-p}) External Mode : Apply the input signal 1 (f ₀ = 10kHz, 0.5V _{p-p}) (2) Measure the sin signal amplitude at pin 19 (V _g) G-Y = 20log (V _g / 0.5V _{p-p})	
34	Video Frequency Characteristics	↑	↑	(40)	↑	↑	↑	↑	Measure input frequency when the output level becomes -3dB.	
35	Maximum Output	↑	↑	(7F)	↑	↑	↑	↑	(1) Same as Note 33 (1) (2) Measure the maximum output level at pin 19.	

NOTE	ITEM	TEST CONDITION (V _{CC} = 9V, T _a = 25 ± 3°C)							
		BUS MODE						MEASUREMENT METHOD	
		(00)	(02)	(03)	(04)	(0B)	(0C)	(0D)	
36	Black Expansion Amp. Gain Black Expansion Start Point	(00)	(00)	(40)	(20)	(80)	(80)	(80)	(1) Apply 1V_{p-p} video signal as follows to video input. (2) Measure the start point and amp gain of Black expansion at pin 19. 
37	DC Restoration	↑	↑	Ad-just	↑	↑	↑	↑	(1) TV Mode : Apply input signal 1 (f₀ = 10kHz 0.5V_{p-p}) to pin 37. External Mode : Apply input signal 1 (f₀ = 10kHz 0.5V_{p-p}) to pin 39. (2) Make pin 42 open. Adjust the data of sub-address (03) so that the output signal amplitude at pin 21 become 0.5V_{p-p}. (3) Measure the pedestal level at pin 21 when no luminance signal is inputted. (ΔV) TCD = (ΔV / 0.5V) × 100% [%]
38	Sharpness Control Characteristics	↑	↑	(40) Ad-just	↑	↑	↑	↑	(1) Apply input signal 1 (20mV_{p-p}) to pin 39. (2) Set the data of sub-address (04) is (3F) (3) Measure the output signal amplitude at B out when the signal (f₀ = 10kHz) is applied (V_{10K}) and when the signal (f₀ = 4MHz) is applied (V_{PK}). G_{SHMAX} = 20log (V_{PK} / V_{10K}) (4) Set the data of sub-address (04) is (00) (5) Measure the output signal amplitude (V_{PK}) at B output when the signal (f₀ = 2.4MHz) is applied. G_{SHMIN} = 20log (V_{PK} / V_{10K}) (6) Set the data of sub-address (04) is (20) (7) Measure the output signal amplitude (V_{PK}) at B output when the signal (f₀ = 4.0MHz) is applied. G_{SHCENT} = 20log (V_{PK} / V_{10K})

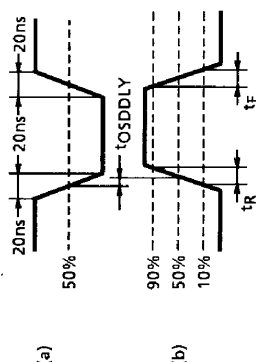
NOTE	ITEM	TEST CONDITION (V _{CC} = 9V, T _a = 25±3°C)										MEASUREMENT METHOD
		BUS MODE										
		(00)	(02)	(03)	(04)	(0B)	(0C)	(0D)				
39	Sharpness Delay Time	(00)	(00)	(40)	(3F)	(80)	(80)	(80)				Measure width of sharpness pulse.
40	Contrast Control Characteristic	↑	↑	Ad-just	(20)	↑	↑	↑	↑			(1) Apply input signal 1 (f ₀ = 10kHz, 0.5V _{p-p}) to pin 39. (2) Set the data of sub-address (03) is (40). (3) Measure the output signal amplitude at pin 21. (V _{CNCENT}) (4) Measure the output signal amplitude at pin 21 when the data of sub-address (03) is set (7F) (V _{CNMAX}) (5) Measure the output signal amplitude at pin 21 when the data of sub-address (03) is set (00) (V _{CNMIN}) GCNMAX = 20log (V _{CNMAX} / V _{CNCENT}) GCNMIN = 20log (V _{CNMIN} / V _{CNMAX})
41	H.V-blanking Output Voltage	↑	↑	(40)	↑	↑	↑	↑	↑			Measure the blanking pulse voltage at pin 21. 
42	V-blanking Width	↑	↑	↑	↑	↑	↑	↑	↑			Measure the blanking pulse width at pin 21.
43	f _{sc} Trap Gain	(80) ↓ (00)	↑	↑	↑	↑	↑	↑	↑			(1) Apply input signal 2. (f ₀ = 3.58MHz, 0.5V _{p-p}) to pin 39. (2) Measure the output signal amplitude at B out when the data of sub-address (00) is set (80). (V _{TON}) (3) Measure the output signal amplitude at B out when the data of sub-address (00) is set (00). (V _{TOFF})

NOTE	ITEM	TEST CONDITION ($V_{CC}=9V$, $T_a=25\pm 3^{\circ}C$)								MEASUREMENT METHOD
		BUS MODE								
		(00)	(02)	(03)	(04)	(08)	(0C)	(0D)		
44	OSD Switching Voltage	(00)	(00)	(40)	(20)	(80)	(80)	(80)	(80)	(1) Apply the external voltage to pin 14. Increase the external voltage from 0V. (2) Measure the voltage at pin 14 when the voltage of pin 19, 20 and 21 at picture period are changed.
45	OSD Delay Time OSD Delay Time Difference Among 3 Axis OSD Rising Time OSD Falling Time	↑	↑	↑	↑	↑	↑	↑	↑	(1) Apply 1.5V to pin 14. (2) Apply the signal as following fig. (a) to pin 15. (3) Measure t_R and t_F of R output at pin 19 according fig. (b) (4) Measure about G and B axis in the same way.
46	Input Clamp Voltage	↑	↑	↑	↑	↑	↑	↑	↑	(1) Apply 1.5V to pin 14. (2) Measure the voltage at pin 15, 16 and 17.

(a)

(b)

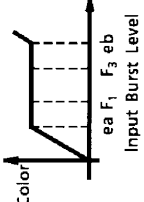
20ns 20ns 20ns 20ns 50% 90% 50% 10% t_R t_F t OSDLY



NOTE	ITEM	TEST CONDITION (V _{CC} = 9V, Ta = 25±3°C)									
		BUS MODE								MEASUREMENT METHOD	
		(00)	(02)	(03)	(04)	(0B)	(0C)	(0D)			
47	OSD Gain	(00)	(00)	(40)	(20)	(80)	(80)	(80)		(1) Apply 1.5V to pin 14. (2) Apply the sine wave signal (10kHz, 0.5V _{p-p}) to pin 15, 16 and 17. (3) Measure the output signal of pin 19, 20 and 21. (V ₄₁) G-OSD = (V ₄₁ / 0.5V _{p-p})	
48	Input Dynamic Range	↑	↑	↑	↑	↑	↑	↑	↑	(1) Apply 1.5V to pin 14. (2) Apply the sine wave signal (10kHz) to pin 15, 16 and 17 with variable amplitude. (3) Consider the output change as 100%. Measure the input signal level when the output signal level is 10%, (V _{di1}) and when the output signal level is 90%. (V _{di2}) V _{diOSD} = V _{di2} - V _{di1}	

NOTE	ITEM	TEST CONDITION (V _{CC} = 9V, T _a = 25±3°C)									MEASUREMENT METHOD
		BUS MODE									
		(00)	(02)	(03)	(0B)	(0C)	(0D)	(0E)	(0F)		
49	Brightness Control Characteristics	(00)	Ad-just	(40)	(80)	(80)	(80)	(80)	(00)	(00)	(1) Apply a color bar signal to pin 39. (2) Measure the pedestal level of RGB output signal at pin 19, 20 and 21 when the data of sub-address (02) is set (7F). (V _{BRTmax}) (3) Measure the pedestal level of RGB output signal at pin 19, 20 and 21 when the data of sub-address (02) is set (40). (V _{BRTcen}) (4) Measure the pedestal level of RGB output signal at pin 19, 20 and 21 when the data of sub-address (02) is set (00). (V _{BRTmin})
50	Brightness Control Difference between 3 Axis.	↑	(40)	↑	↑	↑	↑	↑	↑	↑	(1) Apply a color bar signal to pin 39. (2) Measure the different of pedestal voltage among 3 axis at pin 19, 20 and 21.
51	Cut off Characteristics	↑	↑	↑	Ad-just	Ad-just	Ad-just	Ad-just	↑	↑	(1) Apply a color bar signal to pin 39. (2) Measure the pedestal level of RGB output signal at pin 19, 20 and 21 when the data of sub-address (0B, 0C, 0D) is set (FF) (V _{CUTMAX'}) V _{CUTMAX} = V _{CUTMAX'} - V _{BRTcen} (3) Measure the pedestal level of RGB output signal at pin 19, 20 and 21 when the data of sub-address (0B, 0C, 0D) is set (80) (V _{CUTCEN'}) V _{CUTCEN} = V _{CUTCEN'} - V _{BRTcen} (4) Measure the pedestal level of RGB output signal at pin 19, 20 and 21 when the data of sub-address (0B, 0C, 0D) is set (00) (V _{CUTMIN'}) V _{CUTMIN} = V _{CUTMIN'} - V _{BRTcen}

NOTE	ITEM	TEST CONDITION (V _{CC} = 9V, Ta = 25±3°C)									
		BUS MODE								MEASUREMENT METHOD	
		(00)	(02)	(03)	(0B)	(0C)	(0D)	(0E)	(0F)		
52	Drive Control Characteristics	(40)	(00)	(40)	(80)	(80)	(80)	Ad-just just	Ad-just	(1) Apply the input signal 1 (f ₀ = 10kHz, 0.5V _{p-p}) to pin 39. (2) Measure the voltage of G and B output signal at picture period at pin 20 and 21 when the data of sub-address (0E, 0F) is set (80) (V _{drv_{cen}}) (3) Measure the voltage of G and B output signal at picture period at pin 20 and 21 when the data of sub-address (0E, 0F) is set (FF) (V _{drv_{max}}) G _{drv_{max}} = 20log (V _{drv_{max}} / V _{drv_{cen}}) (4) Measure the voltage of G and B output signal at picture period at pin 20 and 21 when the data of sub-address (0E, 0F) is set (00) (V _{drv_{min}}) G _{drv_{min}} = 20log (V _{drv_{min}} / V _{drv_{cen}})	

NOTE	ITEM	TEST CONDITION (V _{CC} = 9V, T _a = 25±3°C)							MEASUREMENT METHOD
		BUS MODE							
		(00)	(01)	(02)	(03)	(0E)	(0F)		
53	Input Dynamic Range	(40)	(40)	(00)	(40)	(80)	(80)		(1) Change the voltage of external input signal at picture period at pin 39. (2) Consider the output change at pin 21 as 100%. Measure the output signal amplitude at pin 21 when the output signal is 10% (V _{di1}) and when the output signal is 90% (V _{di2}). V _{di45} = V _{di2} - V _{di1}
54	ACC Characteristic	↑	↑	↑	↑	↑	↑	↑	(1) Apply a rainbow color bar signal to pin 39. (2) Measure the RGB output signal as F ₁ and F ₃ at pin 19, 20 and 21 when the input signal level is 100mV _{p-p} and 300mV _{p-p} . A = F ₁ / F ₃ 
55	Killer Point	↑	↑	↑	↑	↑	↑	↑	Apply the burst signal (50mV _{p-p}) to pin 39. Decrease the input level by using ATT. Measure the input burst signal when color killer on.
56	VCXO Frequency Control Range	↑	↑	↑	↑	↑	↑	↑	(1) Measure the DC voltage at pin 11. (V ₁₁) (2) Measure the frequency change at pin 12 when the voltage of pin 11 is change from V ₁₁ -0.5V to V ₁₁ +0.5V.
57	VCXO Frequency Control Sensitivity	↑	↑	↑	↑	↑	↑	↑	(1) Same as Note 57 (1) (2) Same as Note 57 (2) (3) Measure the sensitivity against 1mV at pin 11.

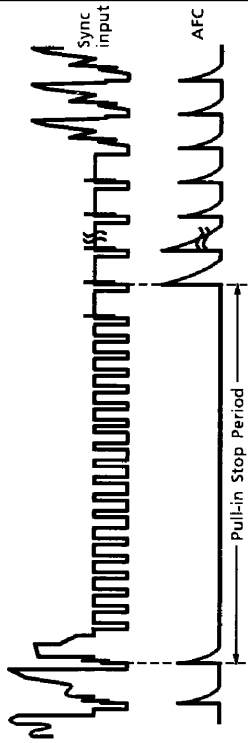
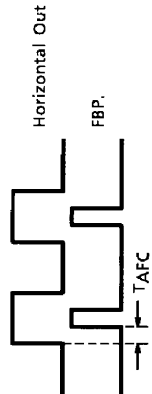
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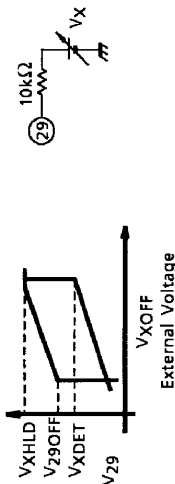
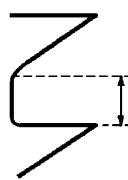
NOTE	ITEM	TEST CONDITION (V _{CC} = 9V, T _a = 25±3°C)							MEASUREMENT METHOD
		BUS MODE							
		(00)	(01)	(02)	(03)	(0E)	(0F)		
58	VCXO Pull-in Range	(40)	(40)	(00)	(40)	(80)	(80)	(1) Apply a rainbow color bar signal to pin 39. (2) Observe the RGB output signal at pin 19, 20 and 21. Change input f _{sc} frequency by 10Hz step up to ±3kHz. Measure the pull-in range.	
59	Demodulate Relative Gain Demodulate Relative Phase	↑	↑	↑	↑	↑	↑	(1) Apply the rainbow color bar signal (f _{sc} = 3.479545MHz, 0.3V _{p-p}) to pin 39. (2) Measure the amplitude and phase of 100Hz signal at pin 19, 20 and 21. Calculate R/B, G/B, R-B, G-B.	
60	Carrier Wave Remain	↑	Ad-just	↑	↑	↑	↑	(1) Apply a rainbow color bar signal to pin 39. (2) Adjust the data of sub-address (01) so that the RGB output amplitude at pin 19, 20 and 21 will be maximum. (3) Apply the signal that has only sync. and burst signal to pin 39. (4) Measure the f _{sc} components of RGB output signal at pin 19, 20 and 21.	
61	Color Control Characteristic	Ad-just	(40)	↑	↑	↑	↑	(1) Apply a rainbow color bar signal to pin 39. (2) Measure the amplitude of RGB output signal at pin 19, 20 and 21 when the data of sub-address (00) is set (7F). (V _{CLRmax}) (3) Measure the amplitude of RGB output signal at pin 19, 20 and 21 when the data of sub-address (00) is set (40). (V _{CLRcen}) GCLRcen = 20log (V _{CLRmax} / CCLRcen) (4) Measure the amplitude of RGB output signal at pin 19, 20 and 21 when the data of sub-address (00) is set (00). (V _{CLRmin}) GCLRmin = 20log (V _{CLRmax} / V _{CLRmin})	

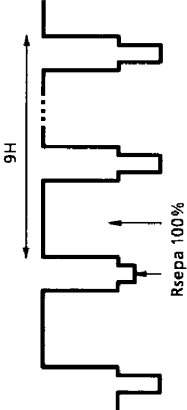
NOTE	ITEM	TEST CONDITION (V _{CC} = 9V, T _a = 25±3°C)							MEASUREMENT METHOD
		BUS MODE							
		(00)	(01)	(02)	(03)	(0E)	(0F)		
62	Uni-color Control Characteristic	(40)	(40)	(00)	Ad-just	(80)	(80)		(1) Apply a rainbow color bar signal to pin 39. (2) Measure the amplitude of RGB output signal at pin 19, 20 and 21 when the data of sub-address (03) is set (7F). (V _{UNImax}) (3) Measure the amplitude of RGB output signal at pin 19, 20 and 21 when the data of sub-address (03) is set (40). (V _{UNIcon}) G _{UNIcon} = 20log (V _{UNImax} / V _{UNIcon}) (4) Measure the amplitude of RGB output signal at pin 19, 20 and 21 when the data of sub-address (03) is set (00). (V _{UNImin}) G _{UNImin} = 20log (V _{UNImax} / V _{UNImin})
63	TINT Control Characteristic	↑	Ad-just	↑	(40)	↑	↑		(1) Apply a rainbow color bar signal to pin 39. (2) Adjust the data of sub-address (01) so that the 6th bar of B output signal at pin 21. (θ _{TNTcen}) (3) Measure phase change of B output signal at pin 21 when the data of sub-address (01) is change from (00) to (7F). (Δθ _{TNT})
64	Video Chroma Delay Time	(40) ↓ (00)	(40)	↑	↑	↑	↑		(1) Apply a rainbow color bar signal to pin 39. (2) Measure rising time of color signal at pin 19, 20 and 21. When the data of sub-address (04) is set (60). (DTC) (3) Measure rising time of Y signal at pin 19, 20 and 21 when the data of sub-address (04) is set (00). (DTY) t _{V-C} = DTY—DTC

NOTE	ITEM	TEST CONDITION (V _{CC} = 9V, T _a = 25 ± 3°C)				MEASUREMENT METHOD
		BUS MODE				
		(05)	(09)	(0A)		
65	Horizontal Free Run Frequency	(10)	(20)	(40)		Measure the frequency of H-out at pin 32. (f _H) f _H = f _{H'} - 15.734kHz
66	Horizontal Out Pulse Duty	↑	↑	↑		Measure the duty of horizontal pulse at pin 32.
67	Horizontal Out Voltage	↑	↑	↑		Measure the high level and low level at pin 32. 
68	VCO Oscillation Start Voltage	↑	↑	↑		Increase H. V _{CC} from 0V at pin 26. Measure the H. V _{CC} at pin 26 when VCO starts oscillation.
69	Horizontal Output Start Voltage	↑	↑	↑		Increase H. V _{CC} from 0V at pin 26. Measure the H. V _{CC} at pin 26 when Horizontal pulse starts to output at pin 32.
70	Horizontal Frequency Control Range	↑	↑	↑		(1) Measure the DC voltage at pin 33. (2) Measure Horizontal frequency control range when the voltage of pin 33 is changed from V ₃₃ - 0.5V to V ₃₃ + 0.5V.
71	Horizontal Frequency Control Sensitivity	↑	↑	↑		(1) Same as Note 71 (1) (2) Same as Note 71 (2) (3) Measure horizontal frequency control sensitivity against 1mV at pin 33.

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NOTE	ITEM	TEST CONDITION (V _{CC} = 9V, T _a = 25±3°C)					MEASUREMENT METHOD
		BUS MODE					
		(05)	(09)	(0A)	SW ₃₀		
72	Horizontal Sync. Pull-in Range	(10)	(20)	(40)	OFF		(1) Apply Sync. signal to pin 39. (2) Observe horizontal output at pin 32. Change the input sync. frequency by 10Hz. Step up to ±3kHz. Measure the pull-in range.
73	Horizontal Sync. Pull-in Stop Period	↑	↑	↑	↑		(1) Apply Sync. signal to pin 39. (2) Observe input sync. signal and pin 33. Measure the pull-in stop period as follows. 
74	AFC-2 Control Range	↑	↑	↑	ON ↓ OFF		(1) SW ₃₀ is on, and delay the rising of FBP from rising of horizontal out by 1μs step. (2) SW ₃₀ is off. Measure the maximum delay time which AFC2 can pull-in. 
75	Horizontal Sync. Position Adjustment	↑	↑	↑	OFF		(1) Measure the phase of horizontal out when the data of sub-address (05) is set (10). (2) Measure phase change when the data of sub-address (05) is change to (00) and (1F).

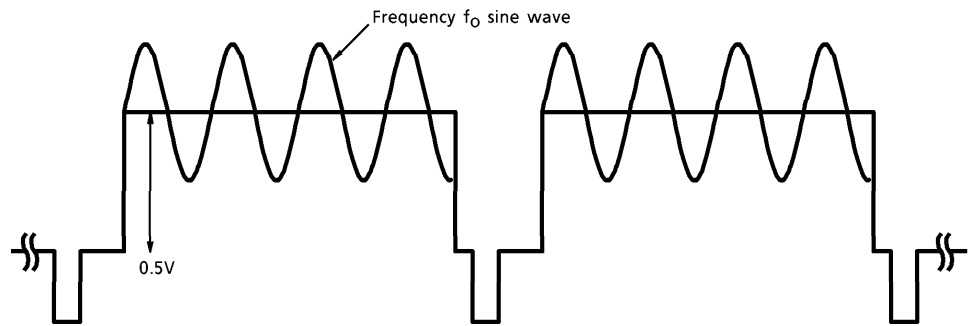
NOTE	ITEM	TEST CONDITION (V _{CC} = 9V, T _a = 25±3°C)				MEASUREMENT METHOD
		BUS MODE				
		(05)	(09)	(0A)		
76	X-RAY Protection detect Voltage X-RAY Protection Hold Voltage X-RAY Protection Hold Current	(10)	(20)	(40)		(1) Connect external voltage supply to pin 29. (2) Measure each point as follows. $V_{XLD} = (V_{29OFF} - V_{XOFF}) / 10k\Omega$ 
77	Vertical Free Run Frequency	↑	↑	↑		Measure vertical frequency at pin 22. (f _{V'}) f _V = f _{V'} / 15.734kHz
78	Vertical Sync. Pull-in Range	↑	↑	↑		(1) Apply sync. signal to pin 39. (2) Observe vertical output at pin 22. Change input frequency by 0.5H step. Measure vertical sync. pull-in range.
79	Vertical Pulse Width	↑	↑	↑		Measure vertical pulse width as follows. 

NOTE	ITEM	TEST CONDITION (V _{CC} = 9V, Ta = 25±3°C)				MEASUREMENT METHOD
		BUS MODE				
		(05)	(09)	(0A)		
80	Vertical Ramp Amplitude Control	(10)	Ad-just	(40)		(1) Measure vertical ramp amplitude when the data of sub-address (09) is set (3F). (V _{VH}) (2) Measure vertical ramp amplitude when the data of sub-address (09) is set (00). (V _{VL})
81	Horizontal Sync. Separation Level	↑	(20)	↑		(1) Apply white 100% signal that has short sync. every 10H to pin 39. (2) Observe sync. separation output at pin 31. Measure sync. separation level by changing sync. length. 
82	Forced V. Osc. (262.5H)	↑		↑	(C0)	(1) Set the data of sub-address (0A) to (C0). (2) Measure vertical frequency at pin 22.

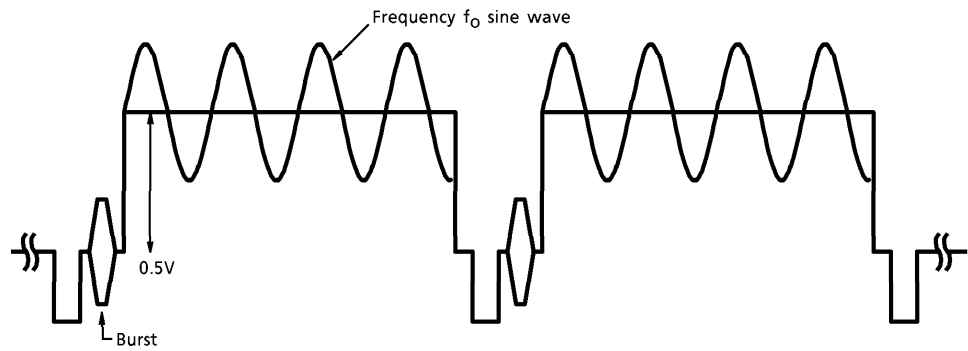
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SIGNAL FOR MEASUREMENT

① Input Signal 1



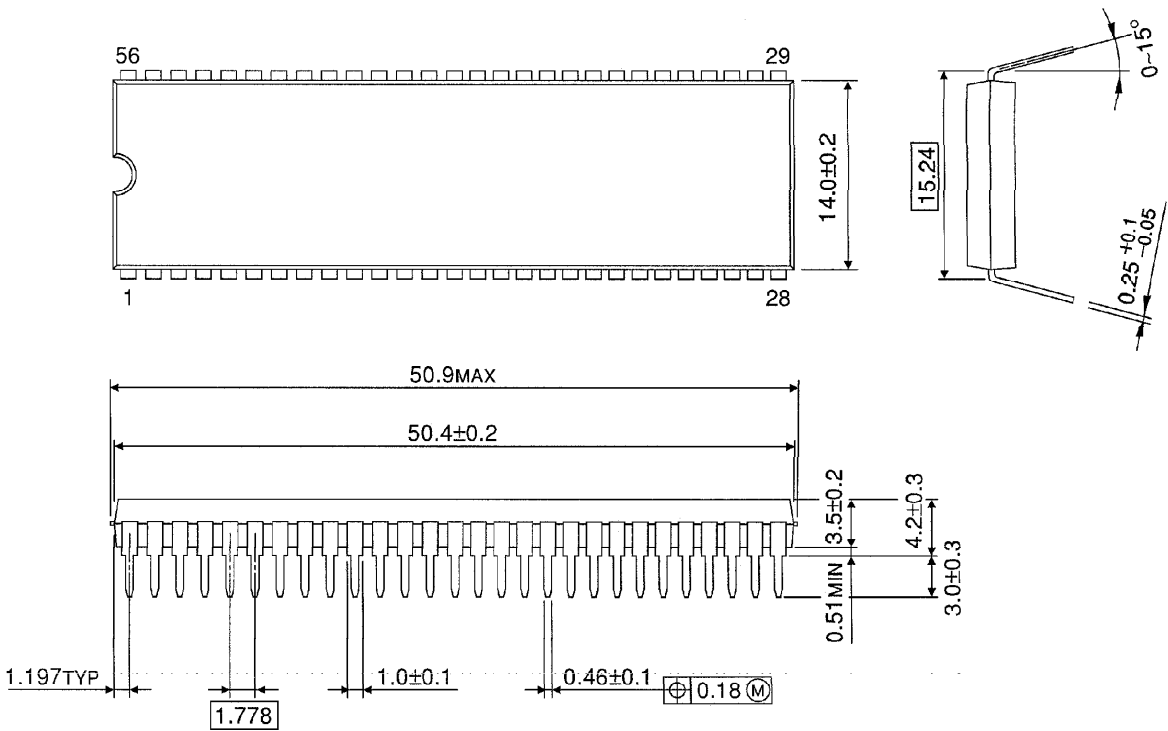
② Input Signal 2



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OUTLINE DRAWING
SDIP56-P-600-1.78

Unit : mm



Weight : 5.55g (Typ.)

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000707EBA

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